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RADIO FREQUENCY INTERCONNECT

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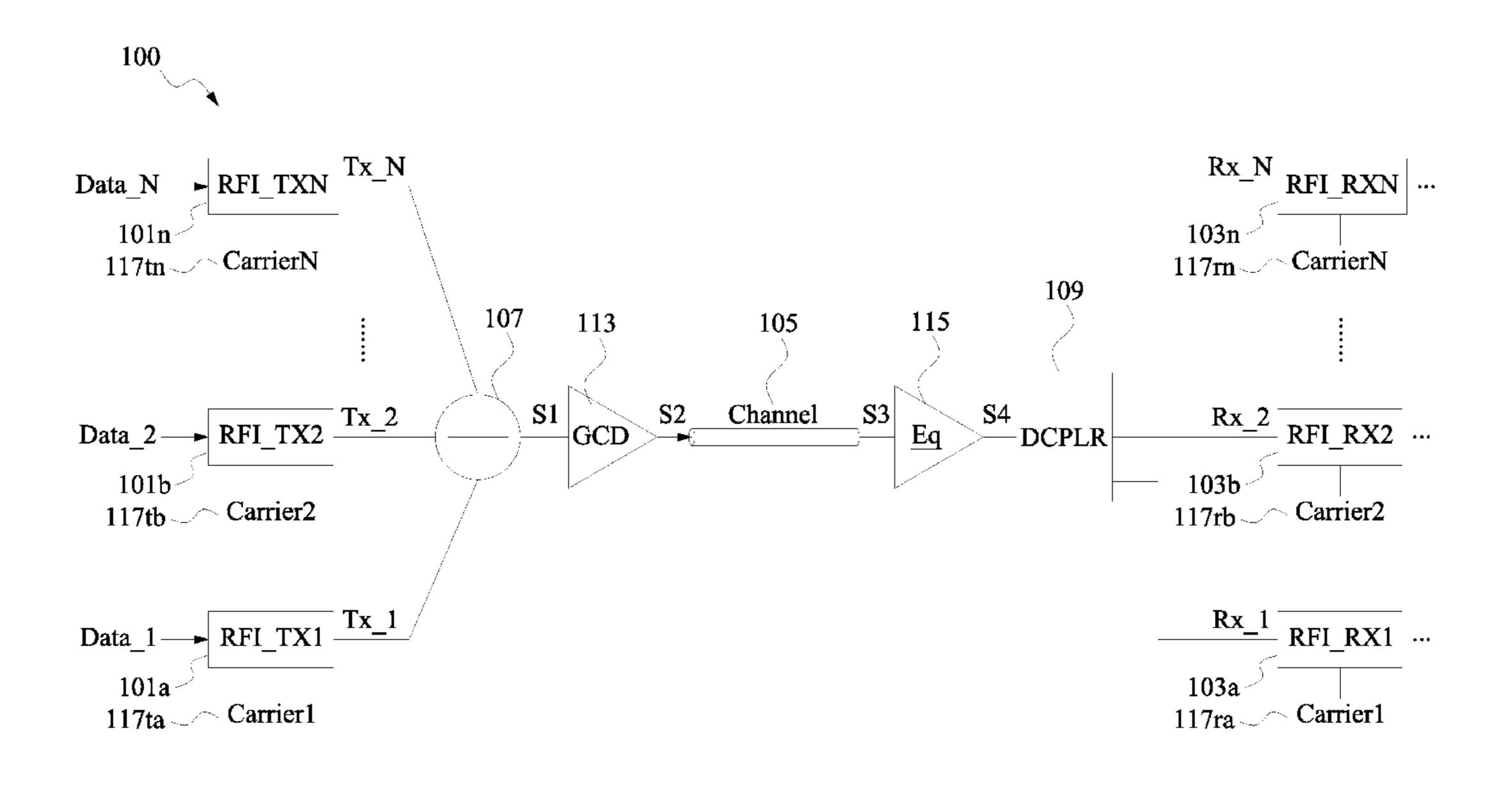
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ABSTRACT (57)

A radio frequency interconnect includes a plurality of transmitters. Each transmitter is associated with an individual carrier of a plurality of carriers. The radio frequency interconnect also includes a transmission channel communicatively coupled with the transmitters and a plurality of receivers communicatively coupled with the transmission channel. Each receiver is associated with a respective carrier. A combiner on a transmitter-side of the transmission channel is coupled with the transmitters between the transmitters and the transmission channel. A decoupler on a receiver-side of the transmission channel is coupled with the receivers between the receivers and the transmission channel. The radio frequency interconnect also includes at least one channel loss compensation circuit communicatively coupled between the plurality of transmitters and the plurality of receivers.

20 Claims, 12 Drawing Sheets



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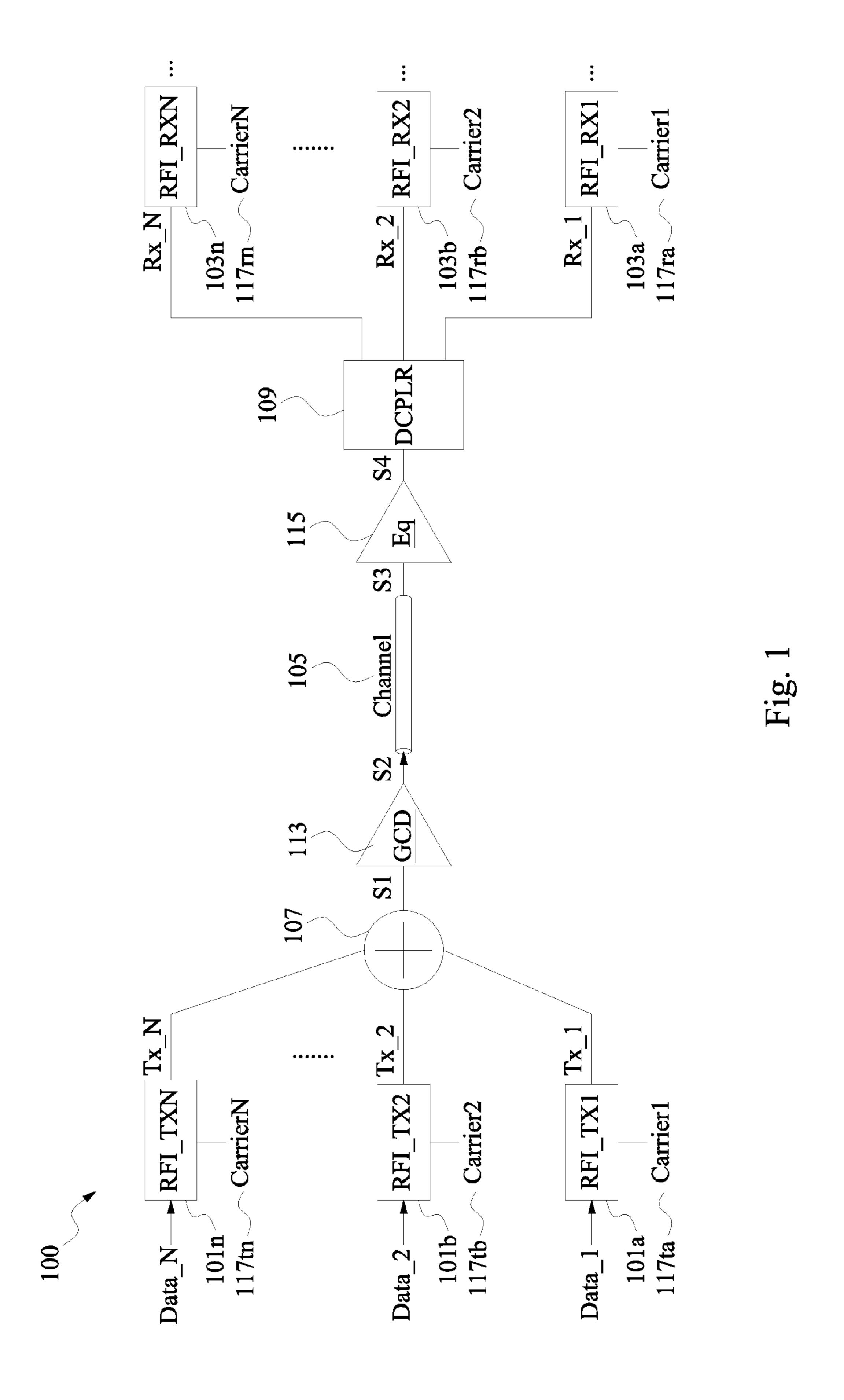
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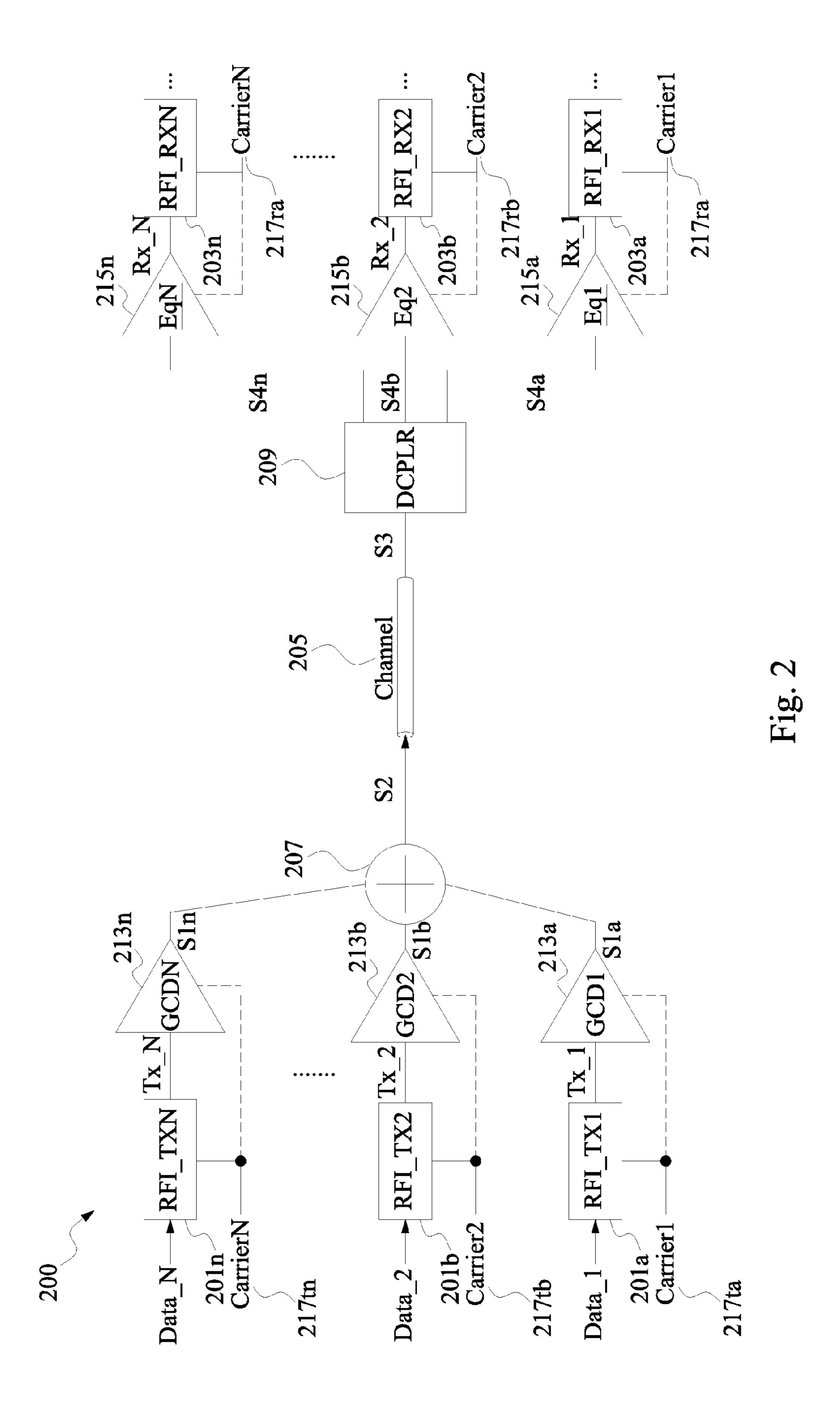
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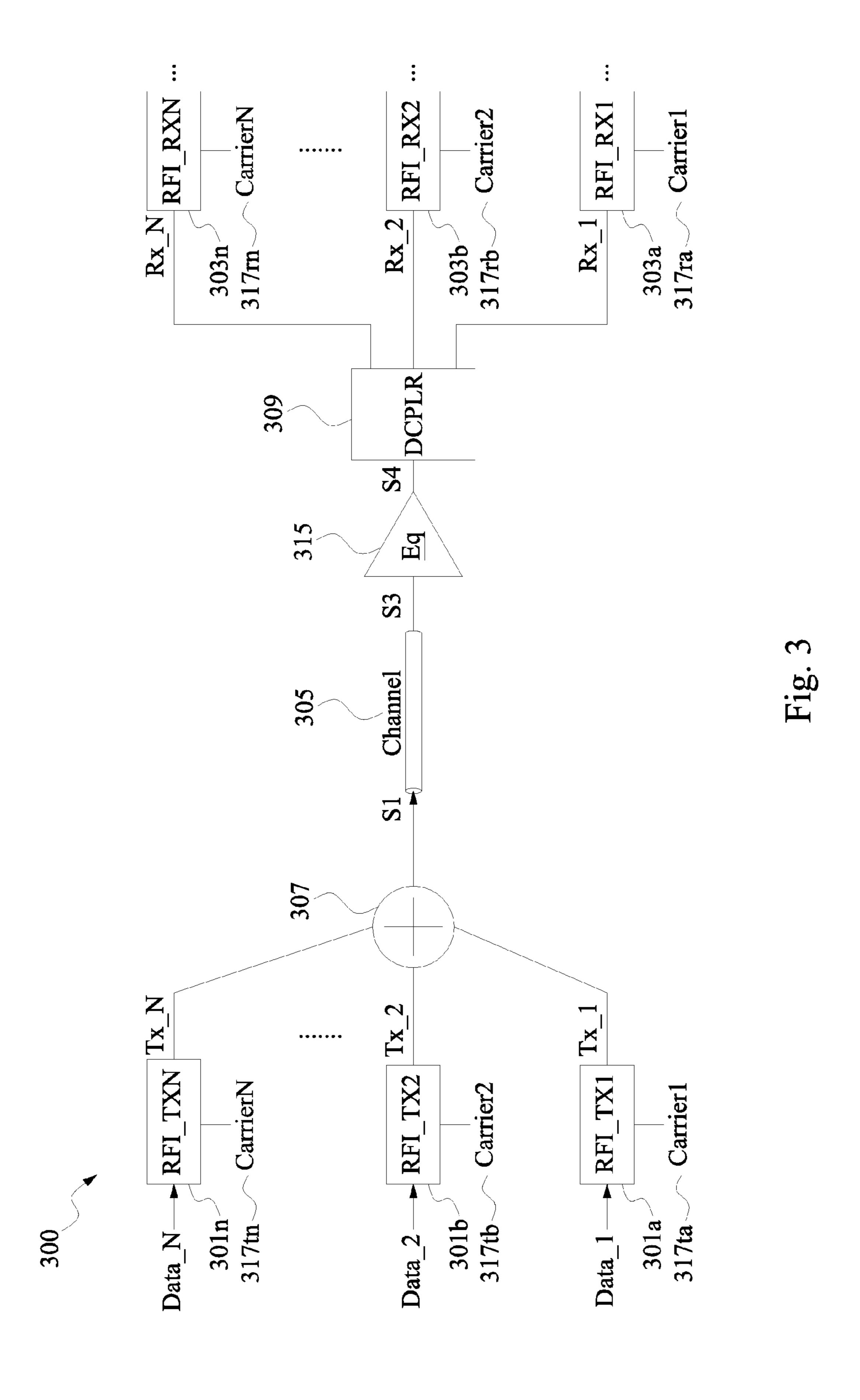
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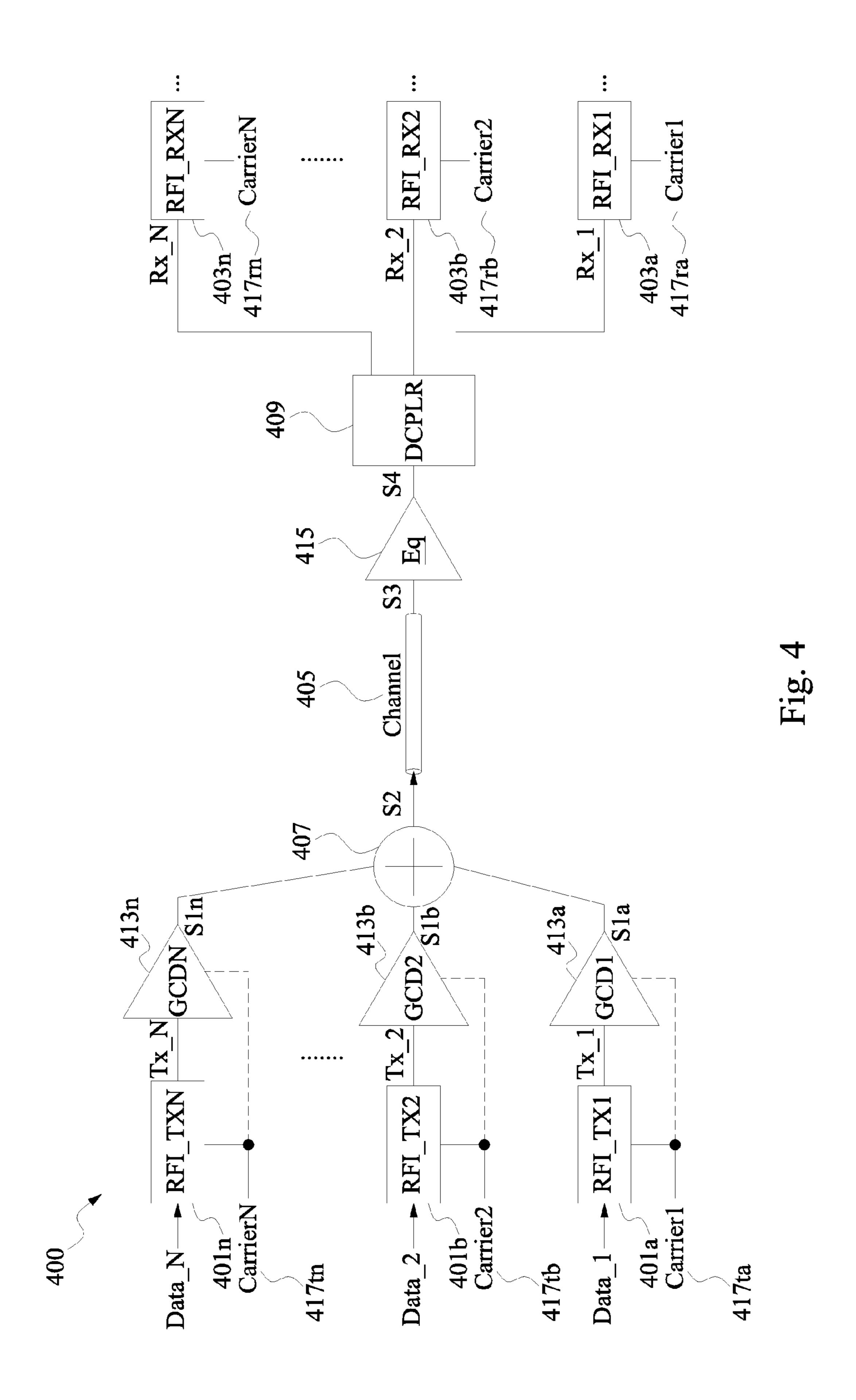
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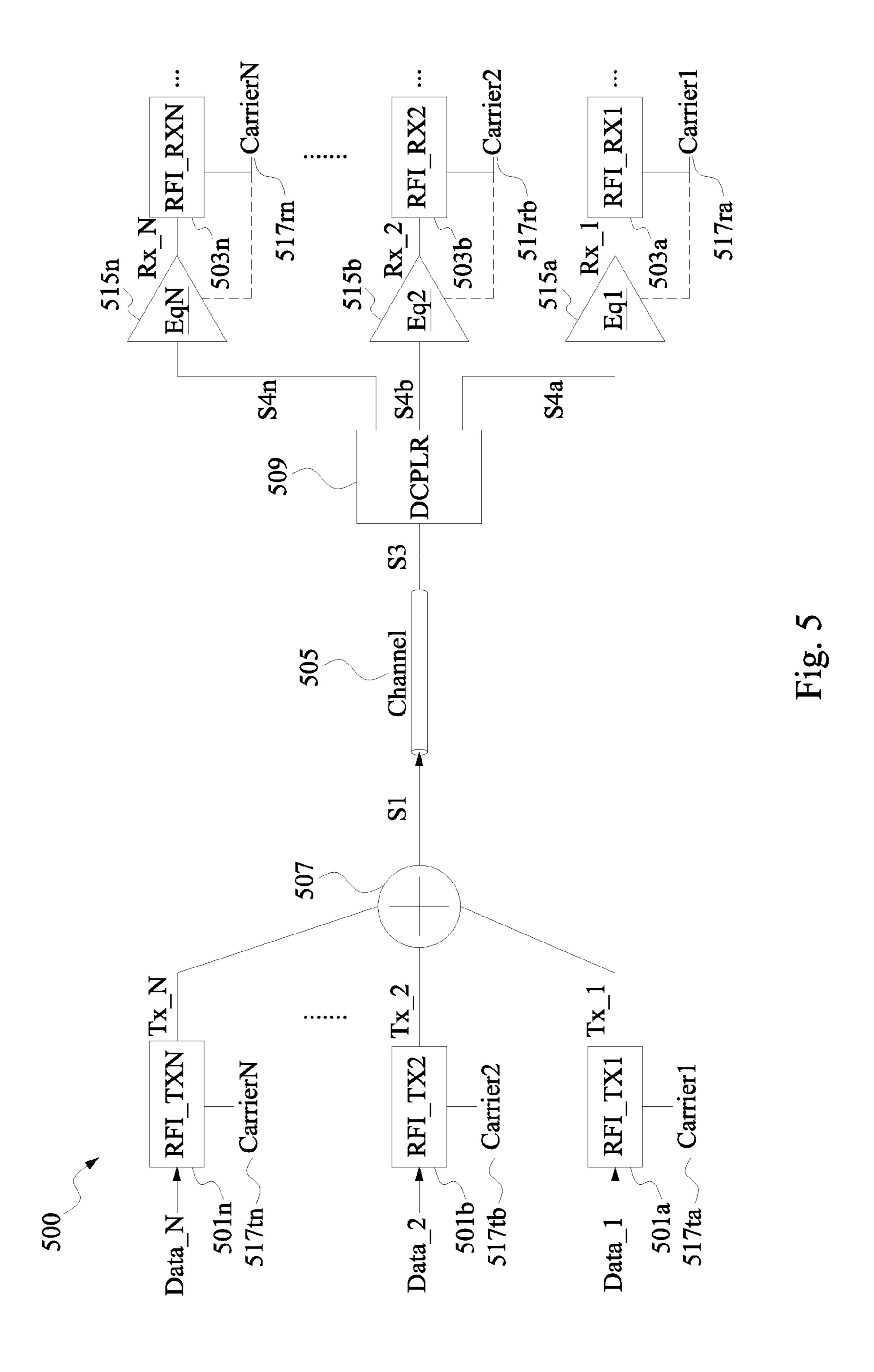
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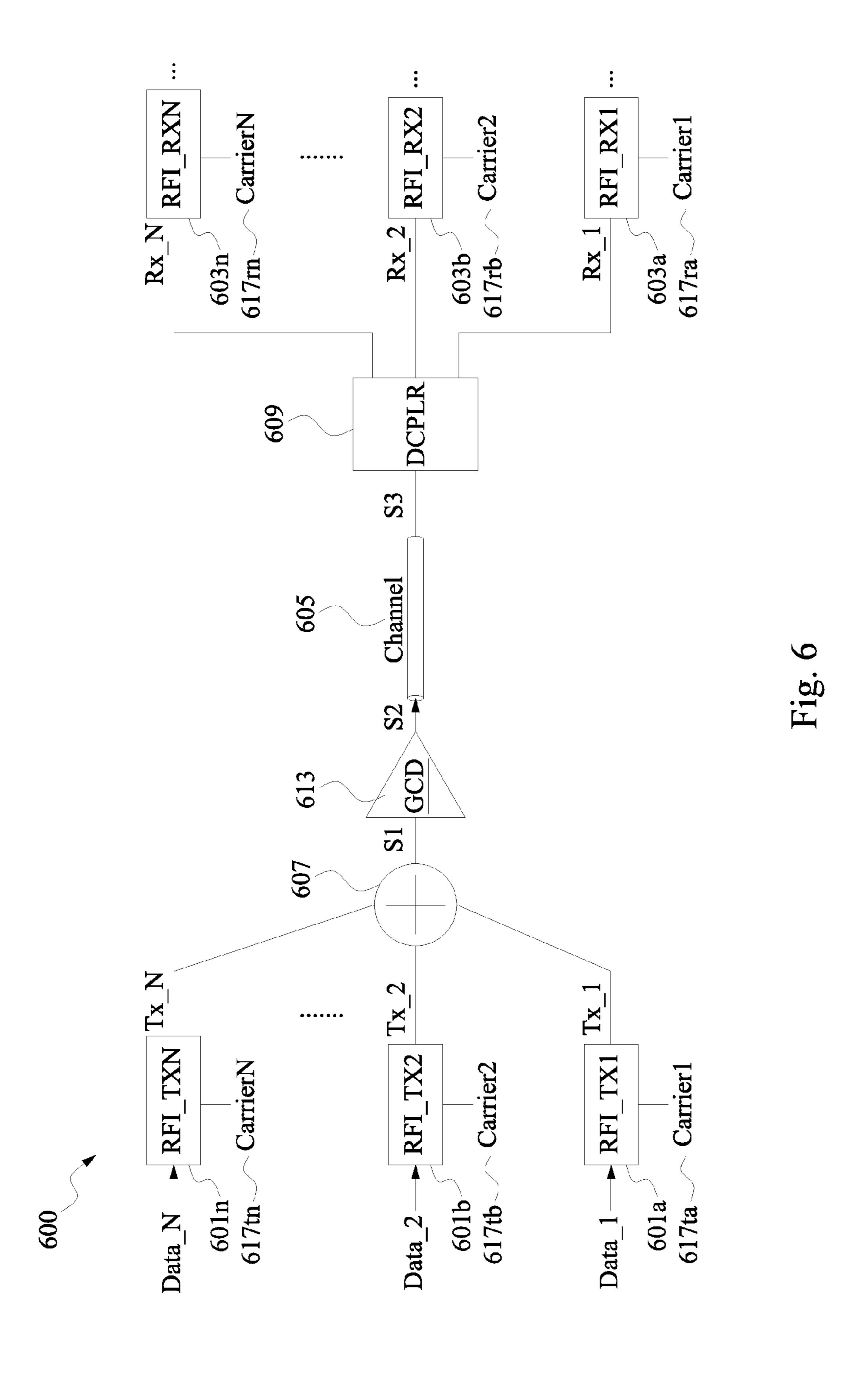


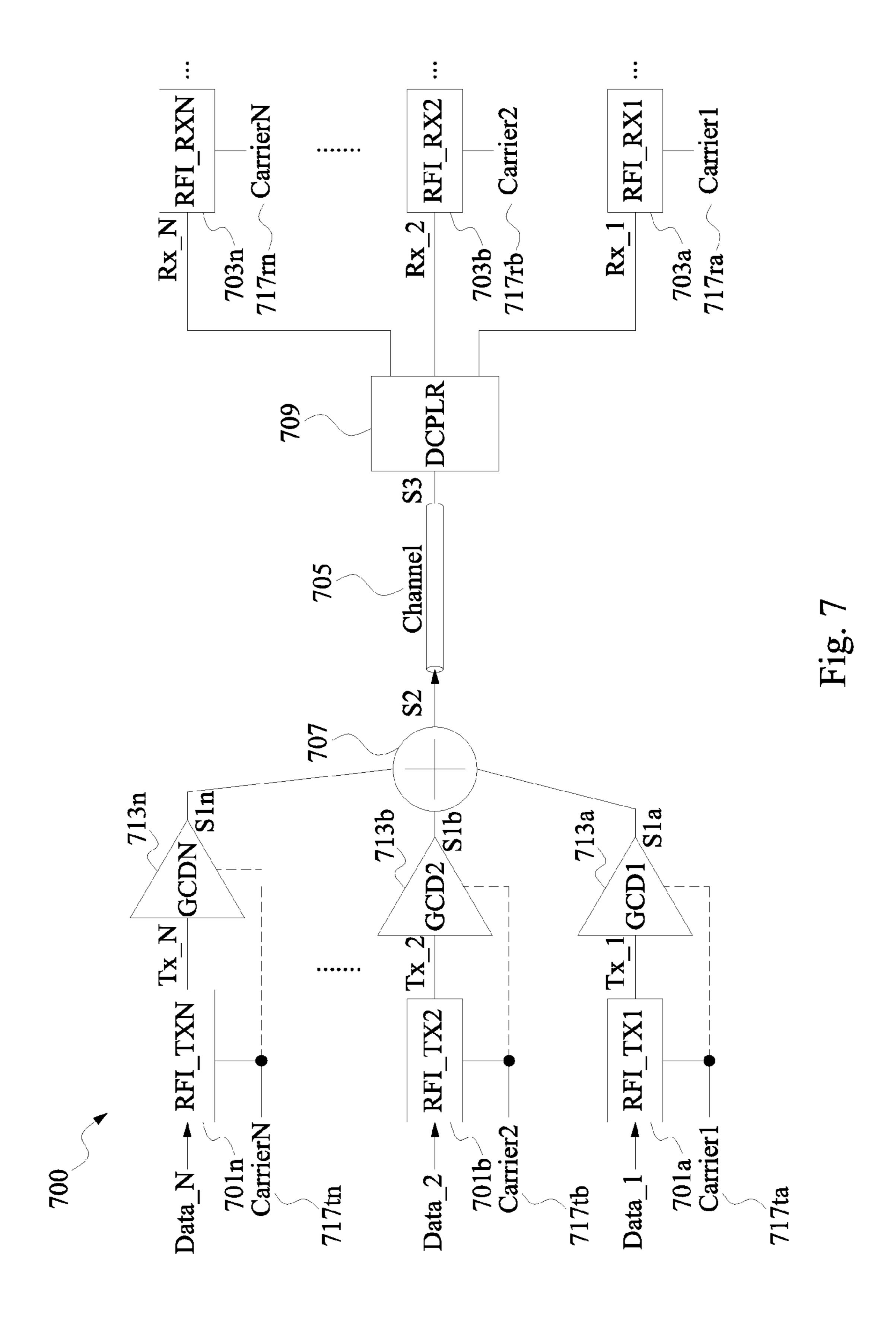




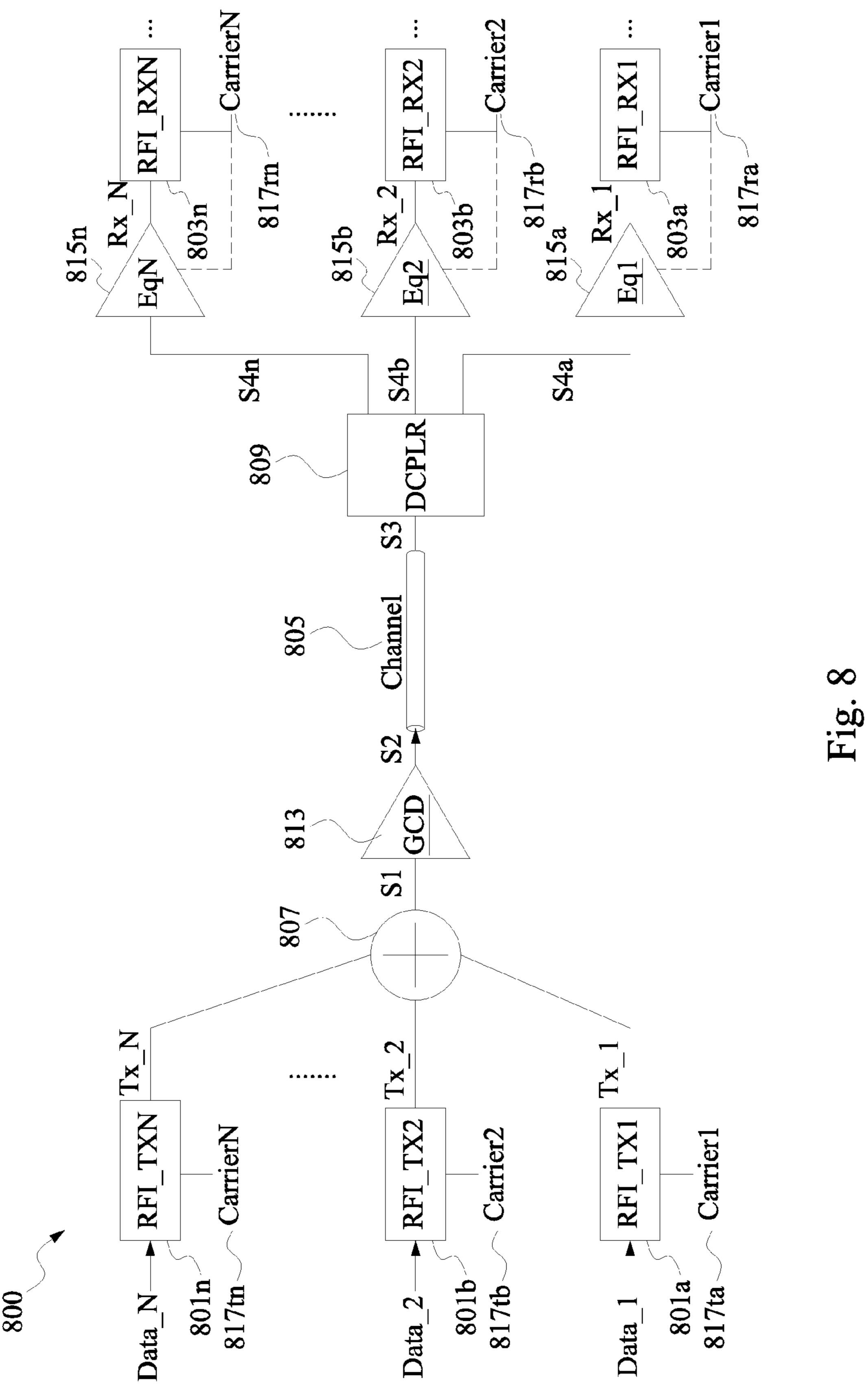


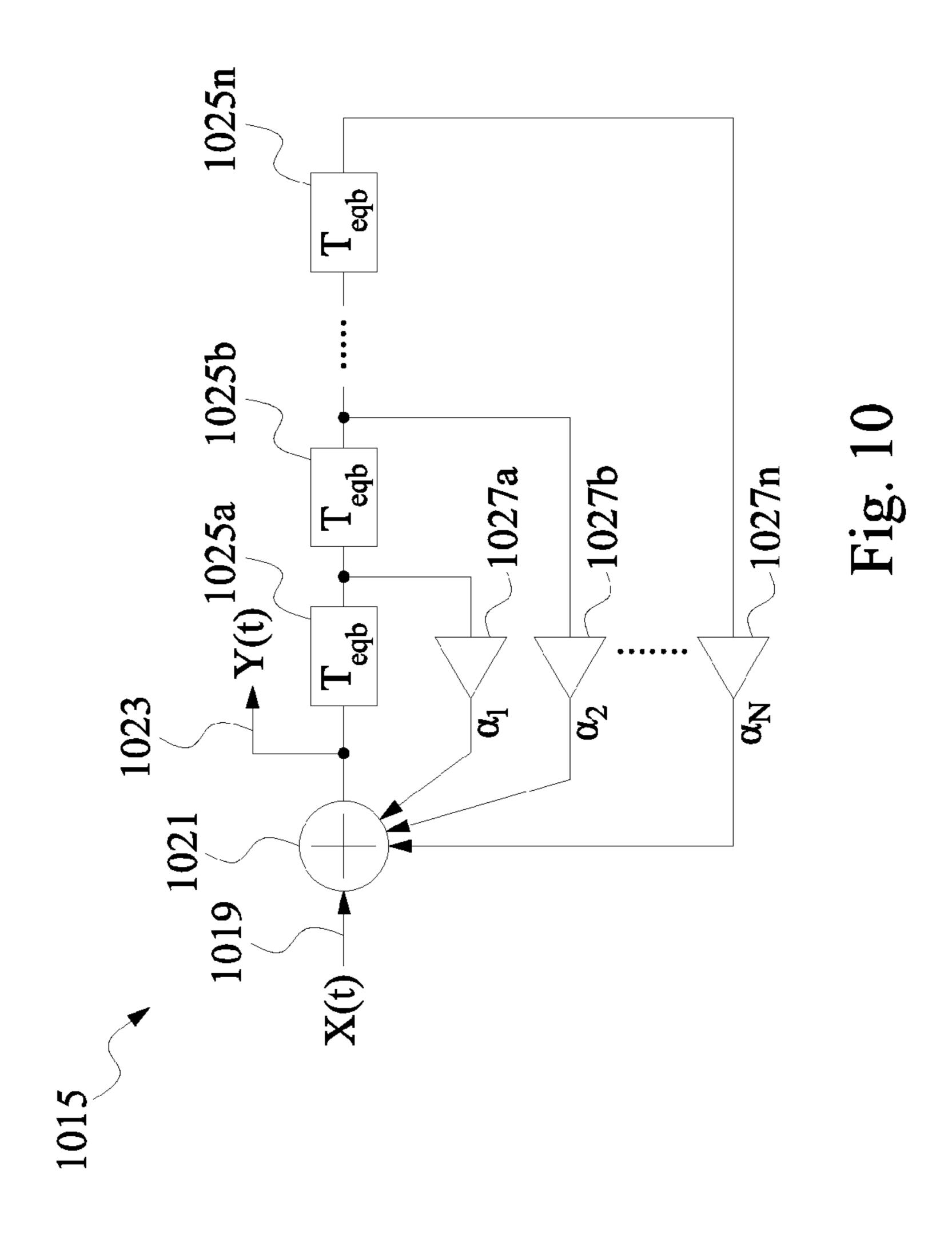


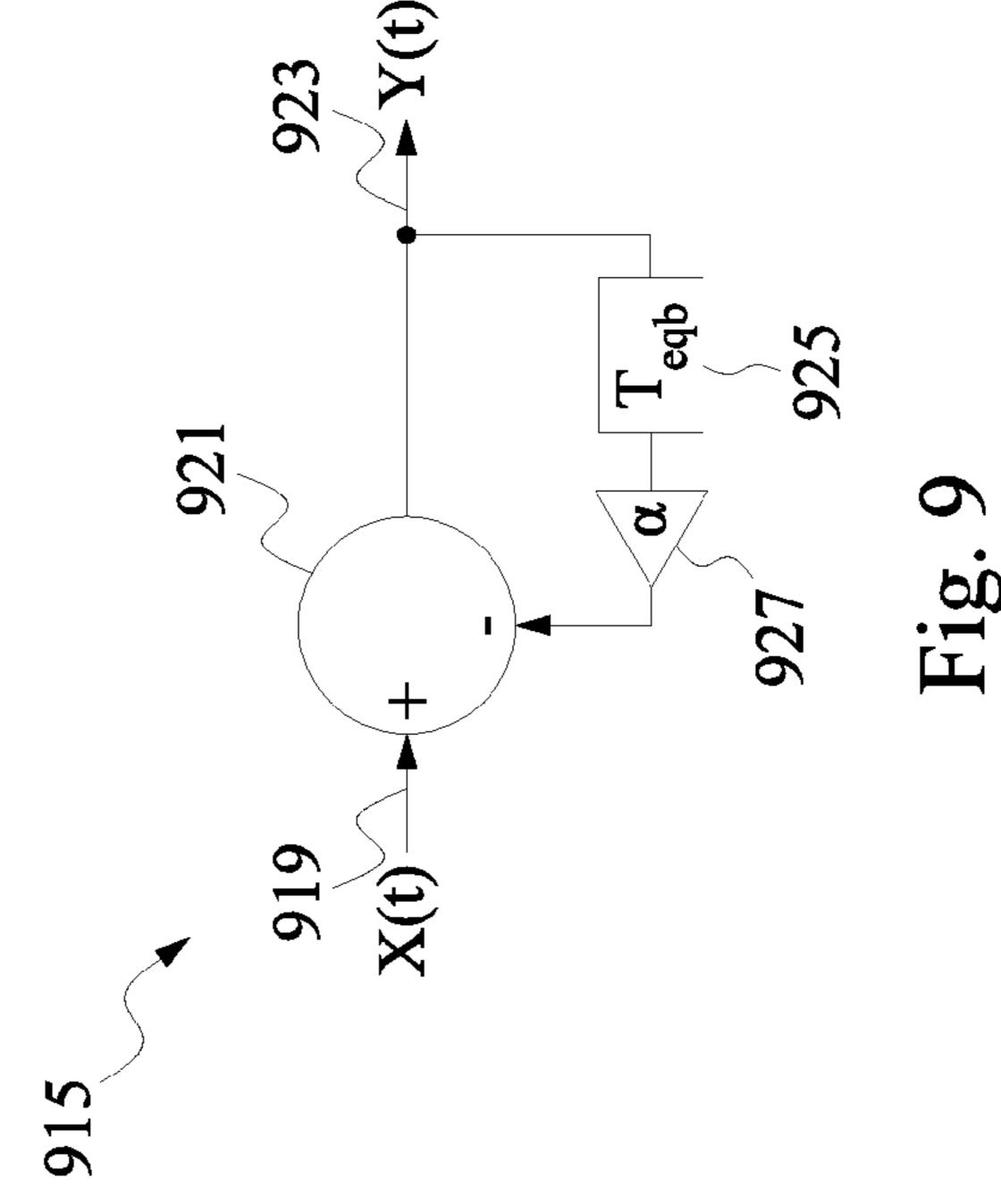


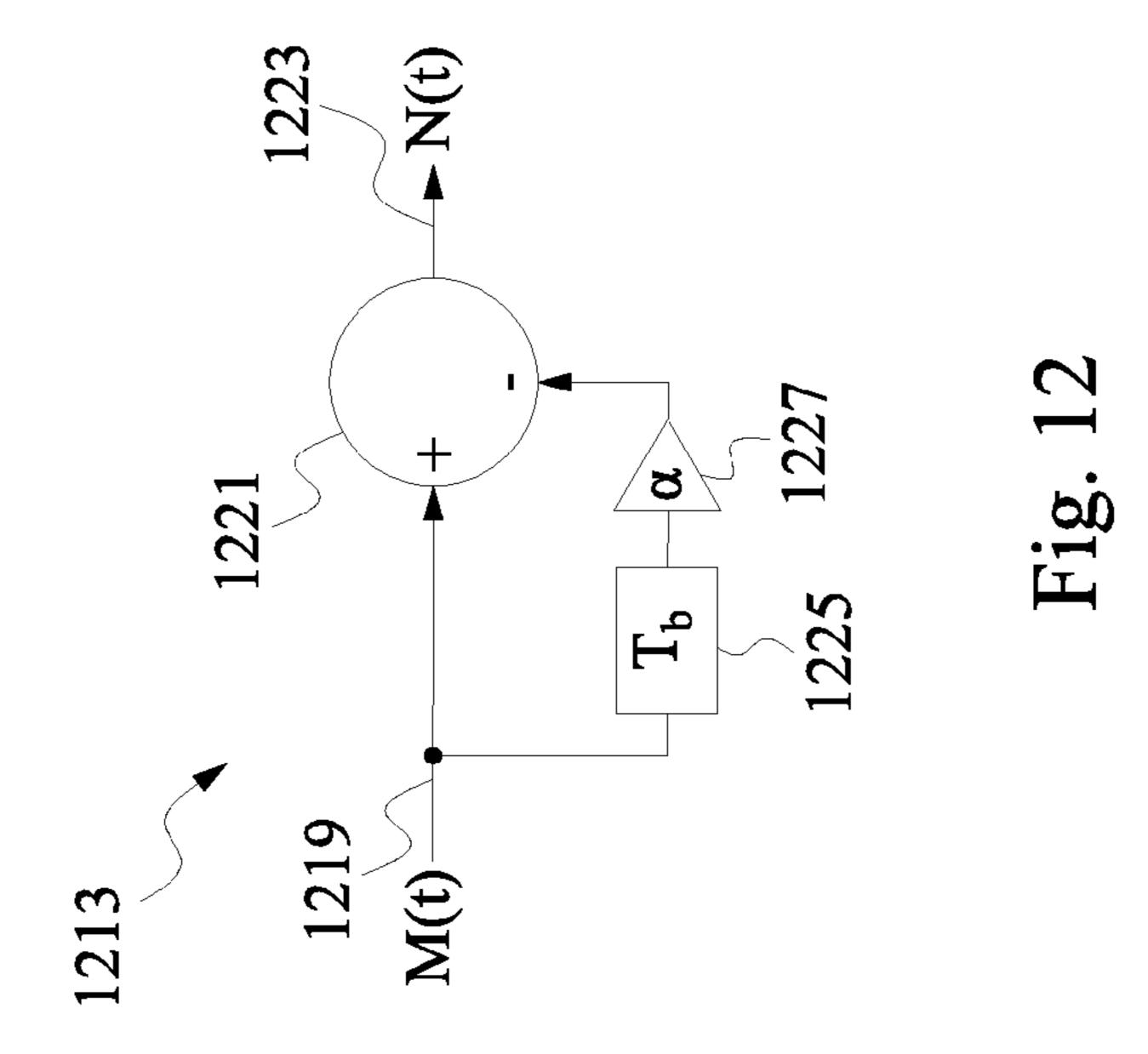


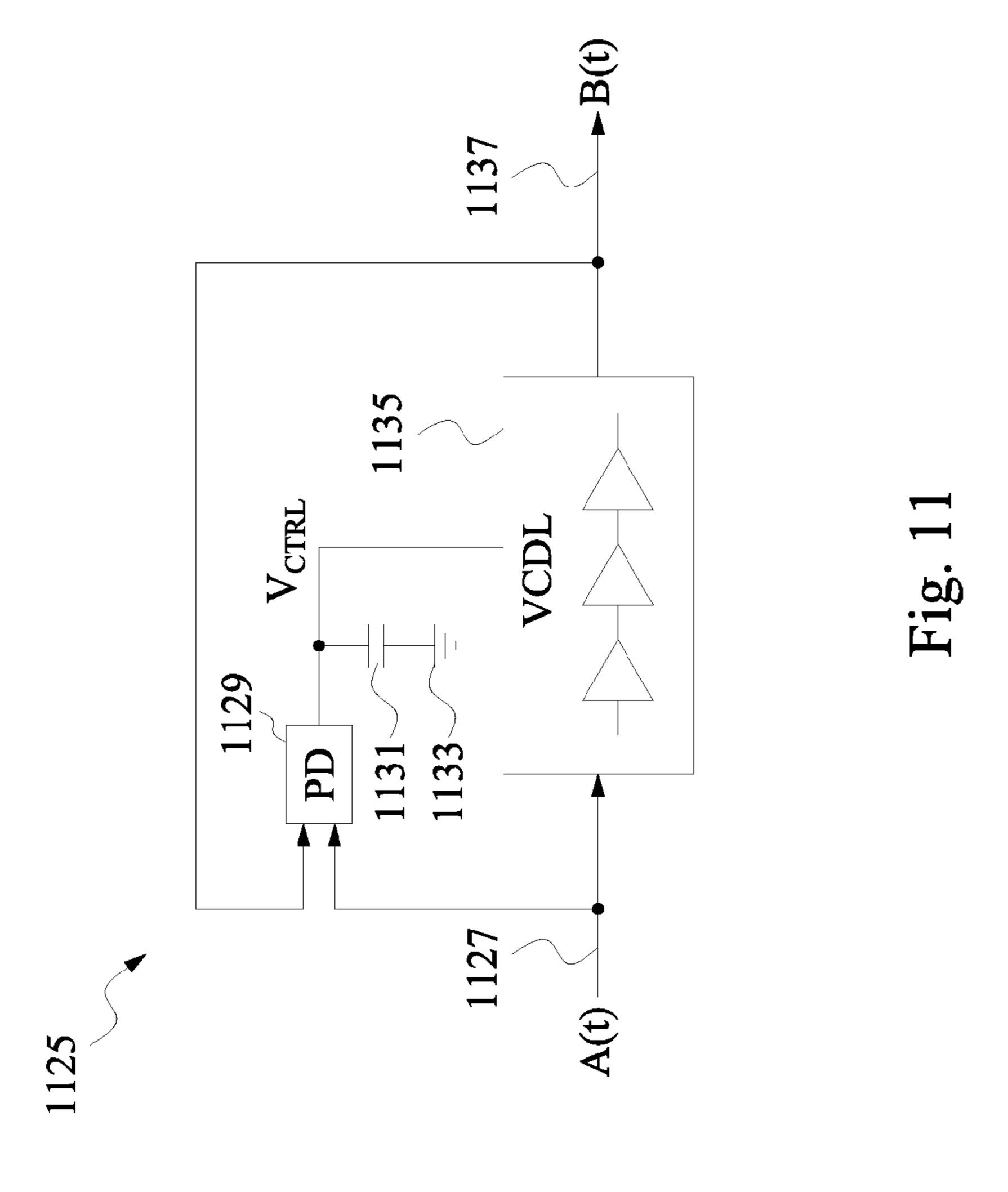
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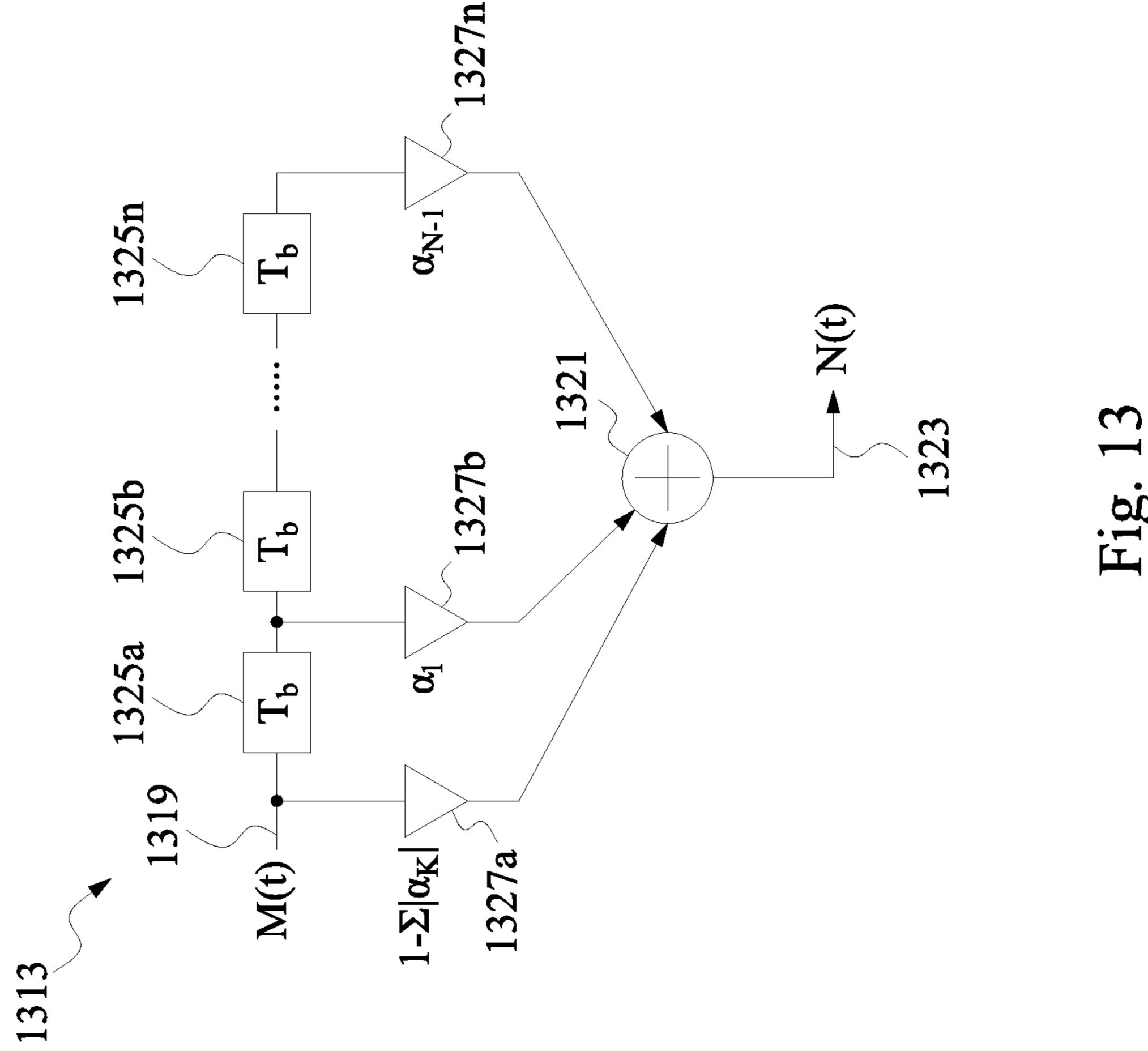


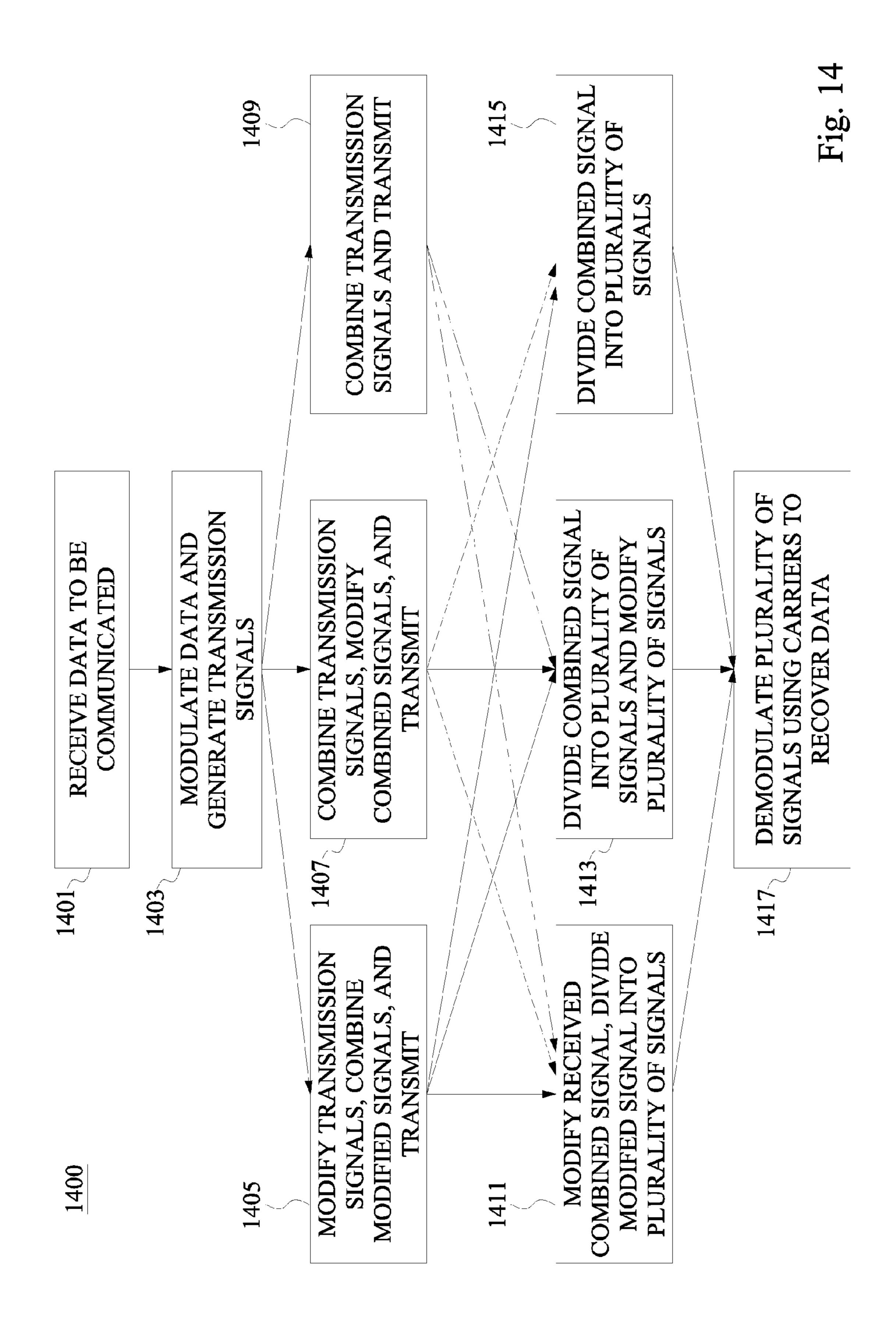












RADIO FREQUENCY INTERCONNECT

BACKGROUND

Radio frequency interconnects (RFIs) are sometimes ⁵ included in an integrated circuit for communicating data between components of the integrated circuit. RFIs include transmitters that communicate data to receivers via a plurality of transmission channels. To transmit the data, the transmitters modulate the data to be transmitted using a plurality of carriers. The modulated data is transmitted to the receivers. To receive the data, the receivers demodulate received signals from the carriers. Each transmission channel has a frequency response, which causes channel loss. For example, five carriers that each have a different frequency ¹⁵ have different channel losses. Channel loss degrades the quality of the transmitted data.

BRIEF DESCRIPTION OF THE DRAWINGS

Aspects of the present disclosure are best understood from the following detailed description when read with the accompanying figures. It is noted that, in accordance with the standard practice in the industry, various features are not drawn to scale. In fact, the dimensions of the various 25 features may be arbitrarily increased or reduced for clarity of discussion.

- FIG. 1 is a block diagram of a radio frequency interconnect, in accordance with one or more embodiments.
- FIG. 2 is a block diagram of a radio frequency intercon- ³⁰ nect, in accordance with one or more embodiments.
- FIG. 3 is a block diagram of a radio frequency interconnect, in accordance with one or more embodiments.
- FIG. 4 is a block diagram of a radio frequency interconnect, in accordance with one or more embodiments.
- FIG. 5 is a block diagram of a radio frequency interconnect, in accordance with one or more embodiments.
- FIG. 6 is a block diagram of a radio frequency interconnect, in accordance with one or more embodiments.
- FIG. 7 is a block diagram of a radio frequency intercon- 40 nect, in accordance with one or more embodiments.
- FIG. 8 is a block diagram of a radio frequency interconnect, in accordance with one or more embodiments.
- FÍG. 9 is a block diagram of an equalizer, in accordance with one or more embodiments.
- FIG. 10 is a block diagram of an equalizer, in accordance with one or more embodiments.
- FIG. 11 is a block diagram of a delay element, in accordance with one or more embodiments.
- FIG. **12** is a block diagram of a gain compensation driver, 50 in accordance with one or more embodiments.
- FIG. 13 is a block diagram of a gain compensation driver, in accordance with one or more embodiments.
- FIG. **14** is a flowchart of a method of transmitting and receiving data, in accordance with one or more embodi- 55 ments

DETAILED DESCRIPTION

The following disclosure provides many different 60 embodiments, or examples, for implementing different features of the provided subject matter. Specific examples of components and arrangements are described below to simplify the present disclosure. These are, of course, merely examples and are not intended to be limiting. For example, 65 the formation of a first feature over or on a second feature in the description that follows may include embodiments in

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which the first and second features are formed in direct contact, and may also include embodiments in which additional features may be formed between the first and second features, such that the first and second features may not be in direct contact. In addition, the present disclosure may repeat reference numerals and/or letters in the various examples. This repetition is for the purpose of simplicity and clarity and does not in itself dictate a relationship between the various embodiments and/or configurations discussed.

RFIs include transmitters that communicate data to receivers using a plurality of carriers. Each transmission channel by which data is communicated to the receivers has a frequency response, which causes channel loss. Channel loss degrades the quality of the transmitted data, and introduces noise to the transmission. The noise introduced has a negative effect on a signal-to-noise ratio that affects the quality of a transmitted signal and the performance of an RFI and increases a risk of errors in decoding the received data.

FIG. 1 is a block diagram of an RFI 100, in accordance 20 with one or more embodiments. RFI 100 comprises a plurality of transmitters 101a-101n (collectively referred to as transmitters 101) configured to transmit data Data_1-Data_N (collectively referred to as transmission data) to a plurality of receivers 103a-103n (collectively referred to as receiver(s) 103) by way of a transmission channel 105. RFI 100 includes a combiner 107 on a transmitter-side of the transmission channel 105 and a decoupler 109 on a receiverside of the transmission channel 105. The combiner 107 is communicatively coupled with the transmitters 101 and the transmission channel 105. The decoupler 109 is communicatively coupled with the receivers 103 and the transmission channel 105. A gain compensation driver 113 is communicatively coupled between the combiner 107 and the transmission channel 105. The transmitters 101 are communica-35 tively coupled with the transmission channel **105** by way of the gain compensation driver 113 and the combiner 107. An equalizer 115 is communicatively coupled between the decoupler 109 and the transmission channel 105. The receivers 103 are communicatively coupled with the transmission channel 105 by way of the equalizer 115 and the decoupler 109.

The transmitters 101 are each associated with a transmission carrier 117ta-117tn and the receivers 103 are each associated with a reception carrier 117ra-117rn (transmis-45 sion carriers and reception carriers are collectively referred to as carriers 117). Carriers 117 are, for example, carrier signals or carrier waves, generated by one or more carrier generators (not shown). Transmission carriers 117ta-117tn have frequencies that correspond to respective reception carriers 117*ra*-117*rn*. The carriers 117 are modulated by the corresponding transmitters 101 to communicate the transmission data to the receivers 103 as a transmission signal. Each transmitter 101 receives respective transmission data Data_1-Data_N and outputs a corresponding transmission signal Tx_1-Tx_N (collectively referred to as transmission signals Tx). The receivers 103 use the receiving carriers 117 to demodulate received transmission signals Rx_1-Rx_N (collectively referred to as received transmission signals Rx) to recover the transmission data. The demodulated transmission data is read by the receivers 103 or output by the receivers 103 to a device capable of reading the demodulated transmission data.

The combiner 107 is configured to receive the transmission signals Tx from the transmitters 101, to combine the transmissions signals Tx, and to output a combined transmission signal S1. Signal S1 is communicated to the decoupler 109 by way of the transmission channel 105. The

transmission channel 105 is a single channel transmission line or medium. In some embodiments, transmission channel 105 is a dual-channel transmission line or medium. In some embodiments, transmission channel 105 is a multi-channel transmission line or medium. In some embodiments, a 5 quantity of channels included in the multi-channel transmission line or medium is less than a quantity of carriers 117.

The transmission channel 105 has a frequency response that causes carriers 117 to have different amounts of channel loss, which affects the amplitude of the received transmission signals Rx. Channel loss reduces a strength of transmission signals Tx and/or signal S1. The channel loss degrades signal-to-noise ratio performance, which negatively affects the quality and/or speed of the received transmission signals Rx corresponding to the transmission sig- 15 nals Tx and/or signal S1. If the quality of the received transmission signals Rx are degraded, then the transmission data recovered therefrom, is degraded. If the speed with which the transmission signals Tx and/or signal S1 propagating through transmission channel 105 is negatively 20 affected, an amount of time taken to recover the transmission data from the received transmission signal Rx is increased, which increases processing times and introduces delay. RFI 100, accordingly, includes gain compensation driver 113 and/or equalizer 115 to compensate for the channel loss and 25 shape the frequency response.

Gain compensation driver 113 is a channel loss compensation circuit configured to receive signal S1 and to output a signal S2 to the transmission channel 105. Signal S2 is a modified signal S1 to compensate for the channel loss 30 introduced by transmission channel 105. The gain compensation driver 113 is configured to generate signal S2 by delaying signal S1 by a delay factor T_{gcdb} , amplifying the delayed signal by a gain factor α_{gcd1} , and adding the amplified delayed signal to signal S1. In some embodiments, 35 the channel loss compensated for by the gain compensation driver 113 is an estimated channel loss, because signal S2 has not yet been transmitted through the transmission channel 105 before signal S1 is received by the gain compensation driver 113. In some embodiments, the channel loss 40 compensated for by the gain compensation driver 113 is based on measured results from passing signals through the transmission channel 105. In some embodiments, gain factor α_{gcd1} is capable of being modified to change the amount the delayed signal is amplified to compensate for different 45 amounts of channel loss.

Signal S2 output by gain compensation driver 113 is transmitted through transmission channel 105 to receivers 103. En route to receivers 103, transmission channel 105 causes channel loss to signal S2 propagating through the 50 transmission channel 105. Signal S3 is output from transmission channel 105. Signal S3 corresponds to signal S2 following the channel loss in the transmission channel 105. In some embodiments, gain factor α_{gcd1} is set at a selected value such that signal S3 is equal to signal S1 or within a 55 predefined signal-to-noise ratio threshold of signal S1 after the channel loss is introduced to signal S2 by transmission channel 105.

Equalizer 115 is a channel loss compensation circuit configured to receive signal S3 and to output a signal S4 to 60 the decoupler 109. Signal S3 is modified by equalizer 115 to compensate for the channel loss introduced by transmission channel 105 and/or excess gain introduced to signal S2 remaining after transmission of signal S2 through transmission channel 105. The equalizer 115 is configured to generate signal S4 by delaying signal S3 by a delay factor T_{eqb} , amplifying the delayed signal by a gain factor α_{eq1} , and

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adding the amplified delayed signal to signal S3. In some embodiments, gain factor α_{eq1} is capable of being modified to change the amount the delayed signal is amplified. Changing gain factor α_{eq1} affects an amount of channel loss the equalizer 115 is configured to compensate. In some embodiments, gain factor α_{eq1} is set at a selected value such that signal S4 is equal to signal S1 or within a predefined signal-to-noise ratio threshold of signal S1 after the gain compensation driver 113 compensates for the channel loss introduced by transmission channel 105 and/or channel loss is introduced to signal S2 by transmission channel 105.

In some embodiments, RFI 100 is free from a gain compensation driver 113. If gain compensation driver 113 is absent from RFI 100, signal S3 received by equalizer 115 is signal S1 (i.e., the combined transmission signals Tx without gain compensation) after signal S1 is transmitted through transmission channel 105.

In some embodiments, RFI 100 is free from including an equalizer 115. If equalizer 115 is absent from RFI 100, signal S3 output by transmission channel 105 is communicated directly to decoupler 109.

Decoupler 109 is configured to receive signal S4. In some embodiments, if the equalizer 115 is absent from RFI 100, then decoupler 109 is configured to receive signal S3. Decoupler 109 is configured to divide a received signal (i.e., signal S4 or signal S3) into received transmission signals Rx, and to communicate the received transmission signals Rx to the respective receivers 103. For example, transmission data Data_1 transmitted by transmitter 101a as transmission signal Tx_1 is communicated to receiver 103a and received by receiver 103a as received transmission signal Rx_1, transmission data Data_2 transmitted by transmitter 101b as transmission signal Tx_2 is communicated to receiver 103b and received by receiver 103b as received transmission signal Rx_2, and transmission data Data_N transmitted by transmitter 101n as transmission signal Tx_N is communicated to receiver 103n and received by receiver 103n as received transmission signal Rx_N.

In some embodiments, RFI 100 is included in an integrated circuit. In some embodiments, RFI 100 is an on-chip interconnect. In some embodiments, RFI 100 is over or at least partially within a substrate. In some embodiments, the components of RFI 100 are divided among two or more integrated circuits or separate substrates. In some embodiments, transmission channel 105 is one or more of a wired or a wireless communication channel.

FIG. 2 is a block diagram of an RFI 200, in accordance with one or more embodiments. RFI 200 comprises many of the features discussed with respect to RFI 100 (FIG. 1), with the reference numerals increased by 100. RFI 200 differs from RFI 100 in that RFI 200 includes a plurality of gain compensation drivers 213a-213n (collectively referred to as gain compensation drivers 213) and a plurality of equalizers 215a-215n (collectively referred to as equalizers 215). The gain compensation drivers 213 are each individually communicatively coupled with respective transmitters 201 and with the combiner 207 on the transmitter-side of the combiner 207. The equalizers 215 are each individually communicatively coupled with respective receivers 203 and with the decoupler 209 on the receiver-side of the decoupler 209. In some embodiments, combiner 207 and decoupler 209 are each directly coupled with transmission channel 205. In some embodiments, at least one intervening device is located between the combiner 207 and the transmission channel 205 or between the decoupler 209 and the transmission channel 205. Gain compensation drivers 213 are coupled with the transmission channel 205 by way of the

combiner 207. Equalizers 215 are coupled with the transmission channel 205 by way of decoupler 209.

In RFI 200, each gain compensation driver 213*a*-213*n* receives respective transmission signal Tx_1-Tx_N from the transmitters 101. The gain compensation drivers 213 are 5 optionally configured to receive carriers 217. The gain compensation drivers 213 are configured to modify the transmission signals Tx to compensate for channel loss and output signals S1*a*-S1*n* to combiner 207. In some embodiments, gain compensation drivers 213 use the carriers 217 to 10 modify transmission signals Tx to generate signals S1*a*-S1*n*.

Gain compensation drivers 213 are configured to generate signals S1a-S1n by delaying signals S1a-S1n by respective delay factors T_{gcdb1} - T_{gcdbn} , amplifying the delayed signals by respective gain factors α_{gcd1} - α_{gcdn} , and adding the amplified delayed signals to the respective transmission signals Tx. In some embodiments, the channel loss compensated for by the gain compensation drivers 213 is an estimated channel loss, because signal S2 has not yet been transmitted through the transmission channel 205 before transmission 20 signals Tx are received by the gain compensation drivers 213. In some embodiments, gain factors α_{gcd1} - α_{gcdn} are capable of being modified to change the amount the delayed signal is amplified. Changing one or more of gain factors α_{gcd1} - α_{gcdn} affects an amount of channel loss for which the 25 gain compensation drivers 213 are configured to compensate. In some embodiments, delay factors T_{gcdb1} - T_{gcdbn} are equal. In some embodiments, delay factors \bar{T}_{gcdb1} - \bar{T}_{gcdbn} are not equal. In some embodiments, delay factors T_{gcdb1} - T_{gcdbn} are based on the carriers 217. In some embodiments, gain 30 factors α_{gcd1} - α_{gcdn} are equal. In some embodiments, gain factors α_{gcd1} - α_{gcdn} are not equal. In some embodiments, gain factors α_{gcd1} - α_{gcdn} are based on the carriers 217.

Combiner 207 is configured to combine signals S1a-S1n and to output signal S2. Signal S2 output by combiner 207 35 is transmitted through transmission channel 205 to receivers 203. En route to receivers 203, transmission channel 205 introduces channel loss to signal S2. Signal S3 is output from transmission channel 205. Signal S3 corresponds to signal S2 after the channel loss is introduced to signal S2 by 40 transmission channel 205.

Decoupler 209 is configured to receive signal S3 and to divide signal S3 into signals S4a-S4n (collectively referred to as signals S4). Signals S4 are communicated to respective equalizers 215 for conversion to received transmission sig-45 nals Rx that are communicated to the respective receivers 203.

Equalizers 215 are configured receive signals S4 and to output received transmissions signals Rx_1-Rx_N to receivers 203. Signals S4 are modified by equalizers 215 to 50 compensate for the channel loss introduced by transmission channel 205 and/or excess gain introduced to signals S1 remaining after transmission of signal S2 through transmission channel **205**. Equalizers **215** are configured to generate received transmission signals Rx_1-Rx_N by delaying sig- 55 nals Rx_1-Rx_N by respective delay factors T_{eqb1} - T_{eqbn} , amplifying the delayed signals by a respective gain factor α_{eq1} - α_{eqn} , and adding the amplified delayed signals to the respective signals S4. In some embodiments, gain factors α_{eq1} - α_{eqn} are capable of being modified to change the 60 amount the delayed signal is amplified. Changing one or more of gain factors α_{eq1} - α_{eqn} affects an amount of channel loss for which the equalizers 215 are configured to compensate. In some embodiments, delay factors T_{eqb1} - T_{eqbn} are equal. In some embodiments, delay factors T_{eqb1} - T_{eqbn} are 65 not equal. In some embodiments, delay factors T_{eqb1} - T_{eqbn} are based on the carriers 217. In some embodiments, gain

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factors α_{eq1} - α_{eqn} are equal. In some embodiments, gain factors α_{eq1} - α_{eqn} are not equal. In some embodiments, gain factors α_{eq1} - α_{eqn} are based on the carriers 217. In some embodiments, gain factors α_{eq1} - α_{eqn} are set at selected values such that received transmissions signals Rx_1-Rx-N are equal to transmission signals Tx_1-Tx_N, or within a predefined signal-to-noise ratio threshold of transmission signals Tx_1-Tx_N after the channel loss is introduced to signal S2 by transmission channel 205.

FIG. 3 is a block diagram of an RFI 300, in accordance with one or more embodiments. RFI 300 comprises many of the features discussed with respect to RFI 100 (FIG. 1), with the reference numerals increased by 200. RFI 300 differs from RFI 100 in that RFI 300 is free from including gain compensation driver 113 (FIG. 1). Signal S1 is transmitted through transmission channel 305. Transmission channel 305 introduces channel loss to signal S1 and outputs signal S3.

FIG. 4 is a block diagram of an RFI 400, in accordance with one or more embodiments. RFI 400 comprises many of the features discussed with respect to RFI 100 (FIG. 1), with the reference numerals increased by 300. RFI 400 differs from RFI 100 in that RFI 400 includes a plurality of gain compensation drivers 413*a*-413*n* and one equalizer 415. As such, in RFI 400, the transmitter-side of transmission channel 405 is configured similar to the transmitter-side of RFI 200 (FIG. 2), and the receiver-side of the transmission channel 405 is configured like the receiver-side of RFI 100 (FIG. 1).

FIG. 5 is a block diagram of an RFI 500, in accordance with one or more embodiments. RFI 500 comprises many of the features discussed with respect to RFI 100 (FIG. 1), with the reference numerals increased by 400. RFI 500 differs from RFI 100 in that RFI 500 is free from including gain compensation driver 113 (FIG. 1). RFI 500 includes a plurality of equalizers 515*a*-515*n*. Signal S1 is transmitted through transmission channel 505. Transmission channel 505 introduces channel loss to signal S1 and outputs signal S3. As such, in RFI 500, the transmitter-side of transmission channel 505 is configured similar to the transmitter-side of RFI 300 (FIG. 3), and the receiver-side of the transmission channel 505 is configured similar to the receiver-side of RFI 200 (FIG. 2).

FIG. 6 is a block diagram of an RFI 600, in accordance with one or more embodiments. RFI 600 comprises many of the features discussed with respect to RFI 100 (FIG. 1), with the reference numerals increased by 500. RFI 600 differs from RFI 100 in that RFI 600 is free from including equalizer 115 (FIG. 1). Signal S2 is transmitted through transmission channel 605. Coupler 609 receives signal S3 and is configured to divide signal S3 into received transmission signals Rx.

FIG. 7 is a block diagram of an RFI 700, in accordance with one or more embodiments. RFI 700 comprises many of the features discussed with respect to RFI 100 (FIG. 1), with the reference numerals increased by 600. RFI 700 differs from RFI 100 in that RFI 700 includes a plurality of gain compensation drivers 713a-713n. RFI 700 is free from including equalizer 115 (FIG. 1). As such, in RFI 700, the transmitter-side of transmission channel 705 is configured similar to the transmitter-side of RFI 200 (FIG. 2), and the receiver-side of the transmission channel 705 is configured similar to the receiver-side of RFI 600 (FIG. 6).

FIG. 8 is a block diagram of an RFI 800, in accordance with one or more embodiments. RFI 800 comprises many of the features discussed with respect to RFI 100 (FIG. 1), with the reference numerals increased by 700. RFI 800 differs

from RFI 100 in that RFI 800 includes one gain compensation driver 813 and a plurality of equalizers 815*a*-815*n*. As such, in RFI 800, the transmitter-side of transmission channel 805 is configured similar to the transmitter-side of RFI 100, and the receiver-side of the transmission channel 805 is configured similar to the receiver-side of RFI 200 (FIG. 2).

FIG. 9 is a block diagram of an equalizer 915, in accordance with one or more embodiments. Equalizer 915 is usable in place of any of the equalizers discussed herein. For example, in some embodiments, equalizer 915 is an example 10 embodiment of equalizer 115 (FIG. 1). One of ordinary skill would recognize that the equalizers discussed herein are not limited the configuration discussed with respect to equalizer 915.

Equalizer 915 comprises a signal input 919, an adder 921 15 coupled with the signal input, a signal output 923 coupled with the adder 921, a delay element 925 coupled with the signal output 923, and an amplifier 927 coupled with the delay element 925 and with the adder 921. Signal input 919 is configured to receive an input signal X(t). Input signal 20 X(t) is representative of a signal received by an equalizer such as signal S3 (FIG. 1) or one of signals S4a-S4n (FIG. 2), for example. Signal output 923 is configured to output an output signal Y(t). Output signal Y(t) is representative of signal S4 (FIG. 1) or one of received transmission signals 25 Rx_1-Rx_N (FIG. 2), in some embodiments. Delay element **925** is configured to receive the output signal Y(t), and delay the output signal Y(t) by delay factor T_{eab} to generate a delayed output signal. Amplifier 927 is configured to receive the delayed output signal, to amplify the delayed output 30 signal by gain factor α_{eqd1} , and to generate an amplified output signal. In some embodiments, amplifier 927 is a programmable gain amplifier having a selectable gain factor α_{ead1} . Adder 921 is configured to receive the input signal X(t), to receive the amplified output signal from amplifier 35 927, and to combine the input signal X(t) with the amplified output signal to generate output signal Y(t).

In some embodiments, delay element 925 is a delay locked loop that causes the output signal Y(t) to be delayed by delay factor T_{eqb} . In some embodiments, delay element 40 925 is a logic circuit configured to cause the output signal Y(t) to be delayed by delay factor T_{eqb} . In some embodiments, delay element 925 is a clock frequency doubler configured to cause the output signal Y(t) to be delayed by delay factor T_{eqb} . In some embodiments, delay factor T_{eqb} 45 delays output signal Y(t) by about half of the clock cycle of the output signal Y(t) to enable equalizer 915 to compensate for channel loss. As such, output signal Y(t) is about 180 degrees out of phase with input signal X(t). In some embodiments, delay factor T_{eqb} delays the output signal Y(t) by a 50 different amount to enable equalizer 915 to compensate for channel loss.

FIG. 10 is a block diagram of an equalizer 1015, in accordance with one or more embodiments. Equalizer 1015 is usable in place of any of the equalizers discussed herein. 55 For example, in some embodiments, equalizer 1015 is an example embodiment of equalizer 115 (FIG. 1). One of ordinary skill would recognize that the equalizers discussed herein are not limited the configuration discussed with respect to equalizer 1015.

Equalizer 1015 includes features similar to those discussed with respect to equalizer 915 (FIG. 9), with the reference numerals increased by 100. Equalizer 1015 differs from equalizer 915 in that equalizer 1015 is a multi-tap equalizer that comprises a plurality of delay elements 65 1025*a*-1025*n* (collectively referred to as delay elements 1025) coupled in series and a plurality of amplifiers 1027*a*-

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1027*n* (collectively referred to as amplifiers 1027) coupled between each delay element 1025 and the adder 1021. A first delay element 1025*a* is configured to receive the output signal Y(t) and to generate a first delayed output signal. Each subsequent delay element 1025 is configured to receive the first delayed output signal or a subsequent delayed output signal from a previous delay element 1025, and to generate a corresponding delayed output signal. The amplifiers 1027 are configured to amplify the first delayed output signal or corresponding subsequent output signals by respective gain factors α_1 - α_N to generate corresponding amplified output signals. Adder 1021 is configured to receive the input signal X(t), to receive the amplified output signals from amplifiers 1027, and to combine the input signal X(t) with the amplified output signals to generate the output signal Y(t).

In some embodiments, the amplifiers 1027 are programmable gain amplifiers with selectable gain factors α_1 - α_N . In some embodiments, gain factors α_1 - α_N are equal to one another. In some embodiments, at least one of the gain factors α_1 - α_N is different from at least one of the other gain factors α_1 - α_N .

FIG. 11 is a block diagram of a delay element 1125, in accordance with one or more embodiments. Delay element 1125 is usable in place of any of the delay elements discussed herein. For example, in some embodiments, delay element 1125 is an example embodiment of delay element 925 (FIG. 9). One of ordinary skill would recognize that the delay elements discussed herein are not limited to the configuration discussed with respect to delay element 1125.

Delay element 1125 comprises a signal input 1127, a phase detector 1129 coupled with the signal input 1127, a capacitor 1131 coupled with the phase detector 1129 and a voltage node 1133 configured to carry a reference voltage, a voltage controlled delay line 1135 coupled with the signal input 1127 and the phase detector 1129, and a signal output 1137 coupled with the voltage delay line 1135 and with the phase detector 1129.

Signal input 1127 is configured to receive an input signal A(t). Input signal A(t) is representative of signal S4 (FIG. 1) or one of received transmission signals Rx_1-Rx_N (FIG. 2) output by the equalizers discussed herein. Output signal B(t) is representative of a delayed output signal generated by delay elements 925 or 1025, for example. The phase detector **1129** is configured to receive the output signal B(t) and the input signal A(t) and to compare the output signal B(t) with the input signal A(t). The phase detector 1129 is configured to determine a phase difference between the output signal B(t) and the input signal A(t). Based on the determined phase difference, the phase detector is configured to output a voltage control signal Vctrl. Based on the voltage control signal Vctrl, the voltage controlled delay line 1135 is configured to modify an amount the output signal B(t) is delayed compared to the input signal A(t). For example, if the delay factor T_{eab} is selected to delay the input signal A(t) by one half of the clock cycle of the input signal B(t), the phase detector 1129 outputs voltage control signal Vctrl to cause the voltage controlled delay line 1135 to delay the input signal A(t) by an amount that results in the output signal B(t) being 180 degrees out of phase with the input signal A(t).

FIG. 12 is a block diagram of a gain compensation driver 1213, in accordance with one or more embodiments. Gain compensation driver 1213 is usable in place of any of the gain compensation drivers discussed herein. For example, in some embodiments, gain compensation driver 1213 is an example embodiment of gain compensation driver 113 (FIG. 1). One of ordinary skill would recognize that the equalizers

discussed herein are not limited to the configuration discussed with respect to gain compensation driver 1213.

Gain compensation driver 1213 comprises a signal input 1219, an adder 1221 coupled with the signal input 1219, a signal output 1223 coupled with the adder 1221, a delay 5 element 1225 coupled with the signal output 1223, and an amplifier 1227 coupled with the delay element 1225 and with the adder 1221. Signal input 1219 is configured to receive an input signal M(t). Input signal M(t) is representative of a signal received by a gain compensation driver 10 N(t). such as signal S1 (FIG. 1) or one of transmission Tx_1-Tx_N (FIG. 2), for example. Signal output 1223 is configured to output an output signal Y(t). Output signal N(t) is representative of signal S2 (FIG. 1) or one of signals S1-Sn (FIG. 2). Delay element 1225 is configured to receive the 15 input signal M(t), and delay the input signal M(t) by delay factor T_{gcdb} to generate a delayed output signal. Amplifier 1227 is configured to receive the delayed input signal, to amplify the delayed output signal by gain factor α_{gcd1} , and to generate an amplified input signal. In some embodiments, 20 amplifier 1227 is a programmable gain amplifier having a selectable gain factor α_{gcd1} . Adder 1221 is configured to receive the input signal M(t), to receive the amplified input signal from amplifier 1227, and to combine the input signal M(t) with the amplified input signal to generate output signal 25 N(t).

In some embodiments, delay element 1225 is a delay locked loop that causes the output signal N(t) to be delayed by delay factor T_{gcdb} . In some embodiments, delay element 1225 is logic circuit configured to cause the output signal 30 N(t) to be delayed by delay factor T_{gcdb} . In some embodiments, delay element 1225 is a clock frequency doubler configured to cause the output signal N(t) to be delayed by delay factor T_{gcdb} . In some embodiments, delay factor T_{gcdb} delays output signal N(t) by about half of the clock cycle of 35 the output signal N(t) to enable gain compensation driver **1213** to compensate for channel loss. In some embodiments, delay factor T_{gcdb} delays the output signal N(t) by a different amount to enable gain compensation driver 1213 to compensate for channel loss. In some embodiments, delay 40 element 1225 comprises a phase detector and a voltage controlled delay line similar to delay element 1125 (FIG. **11**).

FIG. 13 is a block diagram of a gain compensation driver 1313, in accordance with one or more embodiments. Gain 45 compensation driver 1313 is usable in place of any of the gain compensation drivers discussed herein. For example, in some embodiments, gain compensation driver 1313 is an example embodiment of gain compensation driver 113 (FIG. 1). One of ordinary skill would recognize that the gain 50 compensation drivers discussed herein are not limited to the configuration discussed with respect to gain compensation driver 1313.

Gain compensation driver 1313 includes features similar to those discussed with respect to gain compensation driver 55 1213 (FIG. 12), with the reference numerals increased by 100. Gain compensation driver 1313 differs from gain compensation driver 1213 in that gain compensation driver 1313 is a multi-tap gain compensation driver that comprises a plurality of delay elements 1325*a*-1325*n* (collectively 60 referred to as delay elements 1327*a*-1327*n* (collectively referred to as amplifiers 1327*a*-1327*n* (collectively referred to as amplifiers 1327) coupled between each delay element 1325 and the adder 1321. A first delay element 1325*a* is configured to receive the input signal M(t) and to generate 65 a first delayed output signal. Each subsequent delay element 1325 is configured to receive the first delayed output signal

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or a subsequent delayed output signal from a previous delay element 1325, and to generate a corresponding delayed output signal. The amplifiers 1327 are configured to amplify the input signal M(t), the first delayed output signal, or corresponding subsequent output signals by respective gain factors $1-\Sigma|\alpha_K|$, $\alpha_1-\alpha_{N-1}$ to generate corresponding amplified input signals. Adder 1321 is configured to receive the amplified input signals from amplifiers 1327, and to combine the amplified input signals to generate the output signal N(t).

In some embodiments, the amplifiers 1327 are programmable gain amplifiers with selectable gain factors $1-\Sigma|\alpha_K|$, $\alpha_1-\alpha_{N-1}$ that are capable of being changed to modify the overall amount of gain added to or subtracted from input signal M(t). In some embodiments, gain factors $1-\Sigma|\alpha_K|$, $\alpha_1-\alpha_{N-1}$ are equal to one another. In some embodiments, at least one of the gain factors $1-\Sigma|\alpha_K|$, $\alpha_1-\alpha_{N-1}$ is different from at least one of the other gain factors $1-\Sigma|\alpha_K|$, $\alpha_1-\alpha_{N-1}$. In some embodiments, $\alpha_1-\alpha_{N-1}$ are less than zero. In some embodiments, $\alpha_1-\alpha_{N-1}$ are greater than zero.

FIG. 14 is a flowchart of a method 1400 of transmitting and receiving data, in accordance with one or more embodiments. In some embodiments, method 1400 is implemented by a RFI such as one of RFI 100 through RFI 800 discussed with respect to FIGS. 1-8.

In operation 1401, a plurality of transmitters each receive data to be communicated to a plurality of receivers by way of a transmission channel. In step 1403, the transmitters of the plurality of transmitters modulate the received data using carriers associated with the transmitters to generate transmission signals.

Based on the configuration of the RFI used to implement method 1400, method 1400 proceeds to one of operation 1405, operation 1407, or operation 1409.

In operation **1405**, the transmission signals are modified by respective gain compensation drivers to compensate for channel loss introduced by the transmission channel, the modified signals are combined by a combiner into a combined signal, and the combined signal is transmitted through the transmission channel.

In operation 1407, the transmission signals are combined into a combined signal by a combiner, the combined signal is modified by a gain compensation driver, and the modified combined signal is transmitted through the transmission channel.

In operation 1409, the transmission signals are combined into a combined signal by a combiner, and the combined signal is transmitted through the transmission channel.

Based on the configuration of the RFI used to implement method 1400, method 1400 proceeds to one of operation 1411, operation 1413, or operation 1415. Because the RFIs used to implement method 1400 include at least one gain compensation driver or at least one equalizer, method 1400 only proceeds to operation 1415 by way of operation 1405 or operation 1407.

In operation 1411, the combined signal transmitted through the transmission channel is received by an equalizer, modified by the equalizer to compensate for channel loss, and the combined signal modified by the equalizer is divided into a plurality of received transmission signals.

In operation 1413, the combined signal transmitted through the transmission channel is received by a decoupler, divided into a plurality of signals, the plurality of signals are individually received by equalizers of a plurality of equalizers, the equalizers of the plurality of equalizers modify the divided signals to compensate for channel loss and output a plurality of received transmission signals.

In operation 1415, the combined signal transmitted through the transmission channel is received by a decoupler and divided into a plurality of received transmission signals.

In operation 1417, the received transmission signals are demodulated by respective receivers of the plurality of 5 receivers that correspond to the transmitters of the plurality of transmitters using carriers that correspond to the carriers used to modulate the data to be transmitted. Demodulating the received transmission signals results in data that is readable by the receivers or another device coupled with the 10 receivers.

An aspect of this description is related to an integrated circuit comprising a plurality of transmitters. Each transmitter is associated with an individual carrier of a plurality of carriers. The integrated circuit also comprises a transmission 15 channel communicatively coupled with the transmitters of the plurality of transmitters. The integrated circuit further comprises a plurality of receivers communicatively coupled with the transmission channel. Each receiver of the plurality of receivers is associated with a respective carrier of the 20 disclosure. plurality of carriers. The integrated circuit additionally comprises a combiner on a transmitter-side of the transmission channel. The combiner is coupled with the plurality of transmitters between the plurality of transmitters and the transmission channel. The integrated circuit also comprises 25 a decoupler on a receiver-side of the transmission channel. The decoupler is coupled with the plurality of receivers between the plurality of receivers and the transmission channel. The integrated circuit further comprises at least one channel loss compensation circuit communicatively coupled 30 between the plurality of transmitters and the plurality of receivers.

An aspect of this description is related to a radio frequency interconnect comprising a plurality of transmitters. Each transmitter of the plurality of transmitters is associated 35 with an individual carrier of a plurality of carriers. The radio frequency interconnect also comprises a transmission channel communicatively coupled with the plurality of transmitters. The radio frequency interconnect further comprises a plurality of receivers communicatively coupled with the 40 transmission channel. Each receiver of the plurality of receivers is associated with a respective carrier of the plurality of carriers. The radio frequency interconnect additionally comprises a combiner on a transmitter-side of the transmission channel. The combiner is coupled between the 45 plurality of transmitters and the transmission channel. The radio frequency interconnect further comprises at least one gain compensation driver on the transmitter-side of the transmission channel. The at least one gain compensation driver is communicatively coupled between the transmission 50 plurality of receivers. channel and the plurality of transmitters.

An aspect of this description is related to a radio frequency interconnect comprising a plurality of transmitters. Each transmitter is associated with an individual carrier of a plurality of carriers. The radio frequency interconnect fur- 55 ther comprises a transmission channel communicatively coupled with the transmitters of the plurality of transmitters. The radio frequency interconnect further comprises a plurality of receivers communicatively coupled with the transmission channel. Each receiver of the plurality of receivers 60 is associated with a respective carrier of the plurality of carriers. The radio frequency interconnect further comprises a combiner on a transmitter-side of the transmission channel. The combiner is coupled with the plurality of transmitters between the plurality of transmitters and the transmission 65 channel. The radio frequency interconnect further comprises a decoupler on a receiver-side of the transmission channel.

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The decoupler is coupled with the plurality of receivers between the plurality of receivers and the transmission channel. The radio frequency interconnect further comprises at least one equalizer on the receiver-side of the transmission channel. The at least one equalizer is communicatively coupled with the decoupler between the transmission channel and the plurality of receivers.

The foregoing outlines features of several embodiments so that those skilled in the art may better understand the aspects of the present disclosure. Those skilled in the art should appreciate that they may readily use the present disclosure as a basis for designing or modifying other processes and structures for carrying out the same purposes and/or achieving the same advantages of the embodiments introduced herein. Those skilled in the art should also realize that such equivalent constructions do not depart from the spirit and scope of the present disclosure, and that they may make various changes, substitutions, and alterations herein without departing from the spirit and scope of the present disclosure.

What is claimed is:

- 1. A radio frequency interconnect, comprising:
- a plurality of transmitters, each transmitter being associated with an individual carrier of a plurality of carriers;
- a transmission channel communicatively coupled with the transmitters of the plurality of transmitters;
- a plurality of receivers communicatively coupled with the transmission channel, each receiver of the plurality of receivers being associated with a respective carrier of the plurality of carriers;
- a combiner on a transmitter-side of the transmission channel, the combiner being coupled between the plurality of transmitters and the transmission channel;
- a decoupler on a receiver-side of the transmission channel, the decoupler being coupled between the plurality of receivers and the transmission channel; and
- at least one channel loss compensation circuit communicatively coupled between the plurality of transmitters and the plurality of receivers.
- 2. The radio frequency interconnect of claim 1, wherein the at least one channel loss compensation circuit comprises an equalizer between the transmission channel and the decoupler.
- 3. The radio frequency interconnect of claim 1, wherein the at least one channel loss compensation circuit comprises a plurality of equalizers having an equal quantity of equalizers to a quantity of receivers included in the plurality of receivers, and an equalizer of the plurality of equalizers is between the decoupler and a corresponding receiver of the plurality of receivers.
- 4. The radio frequency interconnect of claim 1, wherein the at least one channel loss compensation circuit comprises: a signal input configured to receive an input signal;
 - a signal output configured to output an output signal;
 - a delay element configured to receive the output signal and to generate a delayed output signal;
 - a gain amplifier configured to amplify the delayed output signal by a gain level and to generate an amplified output signal; and
 - an adder configured to receive the input signal, to receive the amplified output signal, and to combine the input signal with the amplified signal to generate the output signal.
- 5. The radio frequency interconnect of claim 4, wherein the delay element comprises a phase detector and a voltage controlled delay line, and the phase detector is configured to output a voltage control signal based on the output signal

and the delayed output signal, and the voltage controlled delay line is configured to modify an amount the output signal is delayed based on the voltage control signal.

- **6.** The radio frequency interconnect of claim **1**, wherein the at least one channel loss compensation circuit comprises: 5
 - a signal input configured to receive an input signal; a signal output configured to output an output signal;
 - a plurality of delay elements coupled in series, wherein each delay element of the plurality of delay elements is configured to generate a corresponding delayed output 10 signal;
 - a plurality of gain amplifiers, wherein each gain amplifier of the plurality of gain amplifiers is configured to amplify the corresponding delayed output signal by a corresponding gain level to generate a corresponding 15 amplified output signal; and
 - an adder configured to combine the input signal with the corresponding amplified output signal of each gain amplifier of the plurality of gain amplifiers, and to generate the output signal.
- 7. The radio frequency interconnect of claim 1, wherein the at least one channel loss compensation circuit comprises a gain compensation driver between the transmission channel and the combiner.
- 8. The radio frequency interconnect of claim 1, wherein 25 the at least one channel loss compensation circuit comprises a plurality of gain compensation drivers having an equal quantity of gain compensation drivers to a quantity of transmitters included in the plurality of transmitters, and a gain compensation driver of the plurality of gain compen- 30 sation drivers is between the combiner and a corresponding transmitter of the plurality of transmitters.
- **9**. The radio frequency interconnect of claim **1**, wherein the at least one channel loss compensation circuit comprises a delay element configured to delay a received signal by 35 doubling a clock frequency of the received signal.
 - 10. A radio frequency interconnect, comprising:
 - a plurality of transmitters, each transmitter being associated with an individual carrier of a plurality of carriers;
 - a transmission channel communicatively coupled with the 40 transmitters of the plurality of transmitters;
 - a plurality of receivers communicatively coupled with the transmission channel, each receiver of the plurality of receivers being associated with a respective carrier of the plurality of carriers;
 - a combiner on a transmitter-side of the transmission channel, the combiner being coupled with the plurality of transmitters between the plurality of transmitters and the transmission channel;
 - a decoupler on a receiver-side of the transmission chan- 50 nel, the decoupler being coupled with the plurality of receivers between the plurality of receivers and the transmission channel; and
 - at least one gain compensation driver on the transmitterside of the transmission channel, the at least one gain 55 compensation driver being communicatively coupled with the combiner between the transmission channel and the plurality of transmitters.
- 11. The radio frequency interconnect of claim 10, wherein the at least one gain compensation driver is between the 60 the at least one equalizer comprises: transmission channel and the combiner.
- 12. The radio frequency interconnect of claim 10, wherein the at least one gain compensation driver comprises a plurality of gain compensation drivers having an equal quantity of gain compensation drivers to a quantity of 65 transmitters included in the plurality of transmitters, and one gain compensation driver of the plurality of gain compen-

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sation drivers is between the combiner and each transmitter of the plurality of transmitters.

- 13. The radio frequency interconnect of claim 10, wherein the at least one gain compensation driver comprises:
 - a signal input configured to receive an input signal;
 - a signal output configured to output an output signal;
 - a delay element configured to receive the input signal and to generate a delayed input signal;
 - a gain amplifier configured to amplify the delayed input signal by a gain level and to generate an amplified input signal; and
 - an adder configured to receive the input signal, to receive the amplified input signal, and to combine the input signal with the amplified input signal to generate the output signal.
- **14**. The radio frequency interconnect of claim **13**, wherein the delay element comprises a phase detector and a voltage controlled delay line, and the phase detector is configured to 20 output a voltage control signal based on the input signal and the delayed input signal, and the voltage controlled delay line is configured to modify an amount the input signal is delayed based on the voltage control signal.
 - 15. The radio frequency interconnect of claim 10, further comprising at least one equalizer on the receiver-side of the transmission channel, the at least one equalizer being communicatively coupled between the transmission channel and the plurality of receivers.
 - 16. A radio frequency interconnect, comprising:
 - a plurality of transmitters, each transmitter being associated with an individual carrier of a plurality of carriers;
 - a transmission channel communicatively coupled with the transmitters of the plurality of transmitters;
 - a plurality of receivers communicatively coupled with the transmission channel, each receiver of the plurality of receivers being associated with a respective carrier of the plurality of carriers;
 - a combiner on a transmitter-side of the transmission channel, the combiner being coupled between the plurality of transmitters and the transmission channel;
 - a decoupler on a receiver-side of the transmission channel, the decoupler being coupled between the plurality of receivers and the transmission channel; and
 - at least one equalizer on the receiver-side of the transmission channel, the at least one equalizer being communicatively coupled between the transmission channel and the plurality of receivers.
 - 17. The radio frequency interconnect of claim 16, wherein the at least one equalizer is between the transmission channel and the decoupler.
 - **18**. The radio frequency interconnect of claim **16**, wherein the at least one equalizer comprises a plurality of equalizers having an equal quantity of equalizers to a quantity of receivers included in the plurality of receivers, and an equalizer of the plurality of equalizers is between the decoupler and a corresponding receiver of the plurality of receivers.
 - 19. The radio frequency interconnect of claim 16, wherein
 - a signal input configured to receive an input signal;
 - a signal output configured to output an output signal;
 - a delay element configured to receive the output signal and to generate a delayed output signal;
 - a gain amplifier configured to amplify the delayed output signal by a gain level and to generate an amplified output signal; and

an adder configured to receive the input signal, to receive the amplified output signal, and to combine the input signal with the amplified signal to generate the output signal.

20. The radio frequency interconnect of claim 19, wherein 5 the delay element comprises a phase detector and a voltage controlled delay line, and the phase detector is configured to output a voltage control signal based on the output signal and the delayed output signal, and the voltage controlled delay line is configured to modify an amount the output 10 signal is delayed based on the voltage control signal.

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